ASSOCIATION CONNEC	Material Compo © Copyright 2005. If international and Pan	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and Mfg Information			
Supplier Info	rmation														
Company name* Company unique ID				ique ID	e ID Unique I			ique ID Authority				Response Date*			
onsemi											2024-0	2024-05-21			
Contact Name		Title - Contact			1	Phone - Contact*				Email	Email - Contact*				
Product-Env-Ste	ewards	Product Enviro Compliance				NA				Prod	Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*	Title - Representative]	Phone - Representative*				Email	Email - Representative*				
Product-Env-Ste	ewards	Product Envi	Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com				
Reque	ester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Versi	on	Manufacturing Site		Weight*	UOM	Unit Type	
		MC74ACT245DWR2 LOG CMOS BUS		S INTRFCE OC	CTL	2024-05-21	21 PH1			517.71	mg	Each			
Ianufacturir	ng Proccess Informat	ion													
Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MS		L Rating	Peak Prod	Peak Process Body Temperature Max Time at Pea		eak Tempe	rature Numb	er of Reflow Cy	cles			
Matte Tin (Sn) - annealed		CU Alloy 3		3		260		С	30	sec	onds 3				
omments											·				
TTENTION: M	ISL 3 Rated item requires	Bake and D	Pack (after	electrical test)											
or more inform	ation regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	9.33	mg	Supplier	Silicon (Si)	7440-21-3		9.33	mg
Die Attach	20.68	mg		Epoxy resin	proprietary data		2.068	mg
			Supplier	Silver (Ag)	7440-22-4		16.544	mg
			Supplier	Formaldehyde Polymer	9003-36-5		2.068	mg
Lead Frame	323.98	mg	Supplier	Silver (Ag)	7440-22-4		3.2398	mg
			Supplier	Zinc (Zn)	7440-66-6		0.648	mg
1			Supplier	Iron (Fe)	7439-89-6		8.4235	mg
			Supplier	Copper (Cu)	7440-50-8		311.6688	mg
Mold Compound-Black	158.46	mg		Epoxy resin	proprietary data		7.923	mg
			Supplier	Phenolic Resin	Proprietary Data		3.1692	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.9615	mg
			Supplier	Carbon Black (C)	1333-86-4		0.7923	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		142.614	mg
Plating	4.79	mg	Supplier	Tin (Sn)	7440-31-5		4.79	mg
Wire Bond - Au	0.47	mg	Supplier	Gold (Au)	7440-57-5		0.47	mg